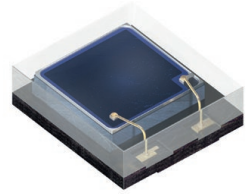


SFH 2704

CHIPLED®

Silicon PIN Photodiode



Applications

- Health Monitoring (Heart Rate Monitoring, Pulse Oximetry)

Features:

- Package: clear epoxy
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- Suitable for reflow soldering
- Especially suitable for applications from 400 nm to 1100 nm
- Small package (LxWxH): 2.0 mm x 1.8 mm x 0.6 mm (WxDxH)

Ordering Information

Type	Photocurrent $E_e = 0.1 \text{ mW/cm}^2; \lambda = 535 \text{ nm}$ I_p	Photocurrent typ. $E_e = 0.1 \text{ mW/cm}^2; \lambda = 535 \text{ nm}$ I_p	Ordering Code
SFH 2704	$\geq 0.35 \mu\text{A}$	0.51 μA	Q65112A7214

Maximum Ratings

$T_A = 25\text{ °C}$

Parameter	Symbol		Values
Operating Temperature	T_{op}	min. max.	-40 °C 85 °C
Storage temperature	T_{stg}	min. max.	-40 °C 85 °C
Reverse voltage	V_R	max.	6 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}	max.	2 kV

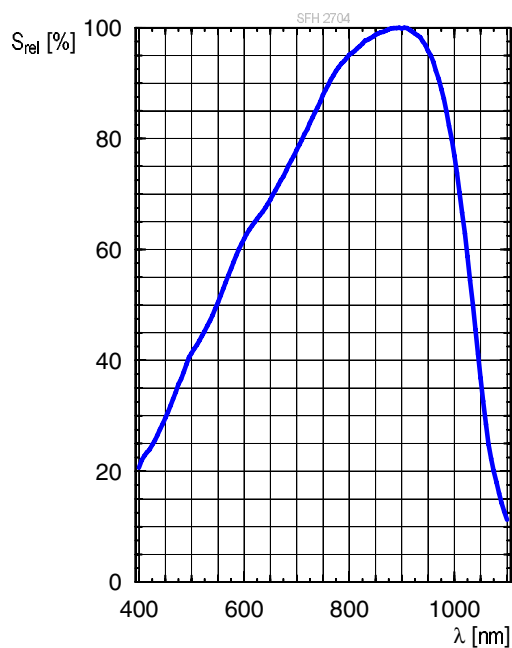
Characteristics

$T_A = 25\text{ °C}$

Parameter	Symbol		Values
Photocurrent $E_e = 0.1\text{ mW/cm}^2$; $\lambda = 535\text{ nm}$; $V_R = 5\text{ V}$	I_P	min. typ.	0.35 μA 0.51 μA
Photocurrent $E_e = 0.1\text{ mW/cm}^2$; $\lambda = 940\text{ nm}$; $V_R = 5\text{ V}$	I_P	min. typ.	0.85 μA 1.22 μA
Wavelength of max sensitivity	$\lambda_{S\text{ max}}$	typ.	900 nm
Spectral range of sensitivity	$\lambda_{10\%}$	typ.	400 ... 1100 nm
Radiant sensitive area	A	typ.	1.51 mm ²
Dimensions of active chip area	L x W	typ.	1.23 x 1.23 mm x mm
Half angle	φ	typ.	60 °
Dark current $V_R = 5\text{ V}$	I_R	typ. max.	0.1 nA 25 nA
Spectral sensitivity of the chip $\lambda = 535\text{ nm}$	S_λ	typ.	0.34 A / W
Quantum yield of the chip $\lambda = 535\text{ nm}$	η	typ.	0.79 Electrons / Photon
Open-circuit voltage $E_e = 0.1\text{ mW/cm}^2$; $\lambda = 535\text{ nm}$; $V_R = 5\text{ V}$	V_O	min. typ.	490 mV 510 mV
Rise time $V_R = 5\text{ V}$; $R_L = 50\text{ }\Omega$; $\lambda = 525\text{ nm}$; $I_P = 600\text{ }\mu\text{A}$	t_r	typ.	47 ns
Fall time $V_R = 5\text{ V}$; $R_L = 50\text{ }\Omega$; $\lambda = 525\text{ nm}$; $I_P = 600\text{ }\mu\text{A}$	t_f	typ.	67 ns
Forward voltage $I_F = 10\text{ mA}$; $E = 0$	V_F	typ.	0.95 V
Capacitance $V_R = 0\text{ V}$; $f = 1\text{ MHz}$; $E = 0$	C_0	typ.	13.4 pF
Noise equivalent power $V_R = 5\text{ V}$; $\lambda = 535\text{ nm}$	NEP	typ.	0.017 pW / Hz ^{1/2}
Detection limit $V_R = 5\text{ V}$; $\lambda = 535\text{ nm}$	D^*	typ.	7.4e12 cm x Hz ^{1/2} / W

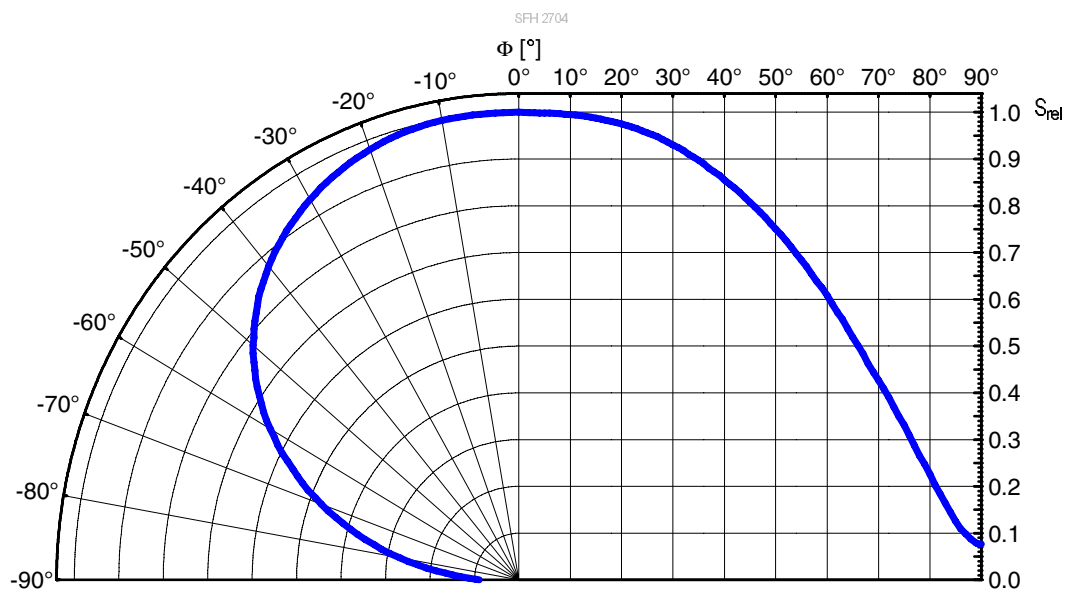
Relative Spectral Sensitivity ^{1), 2)}

$$S_{\text{rel}} = f(\lambda)$$



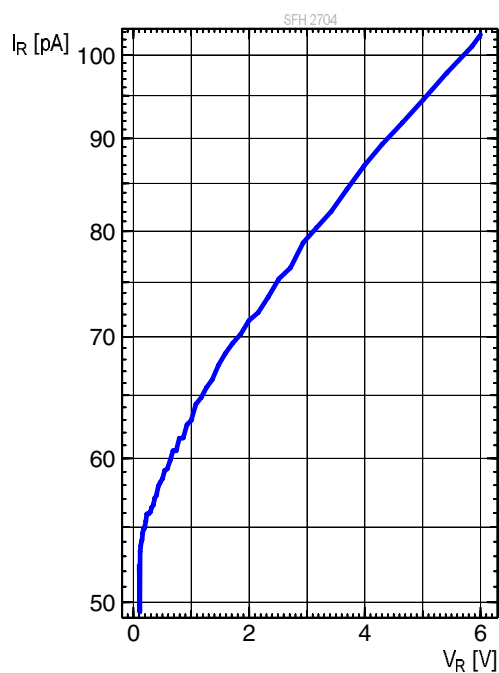
Directional Characteristics ^{1), 2)}

$$S_{\text{rel}} = f(\varphi)$$

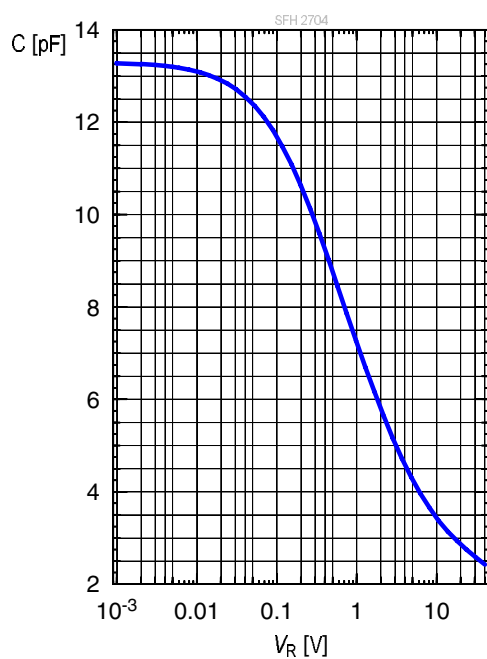


Dark Current ^{1), 2)}

$$I_R = f(V_R); E = 0$$

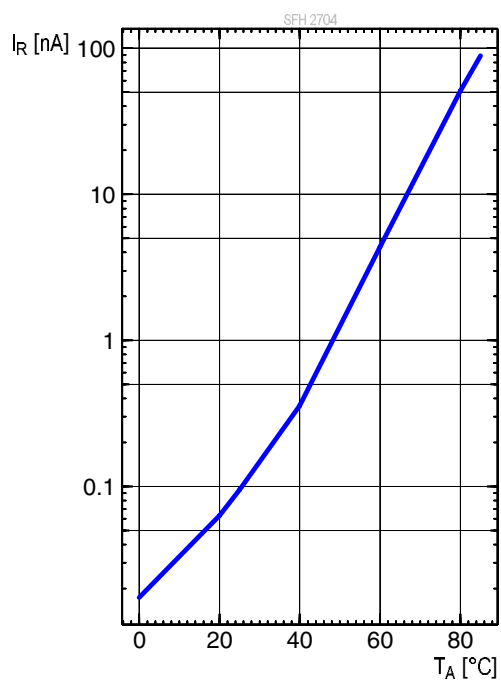
**Capacitance** ^{1), 2)}

$$C = f(V_R); f = 1 \text{ MHz}; E = 0;$$

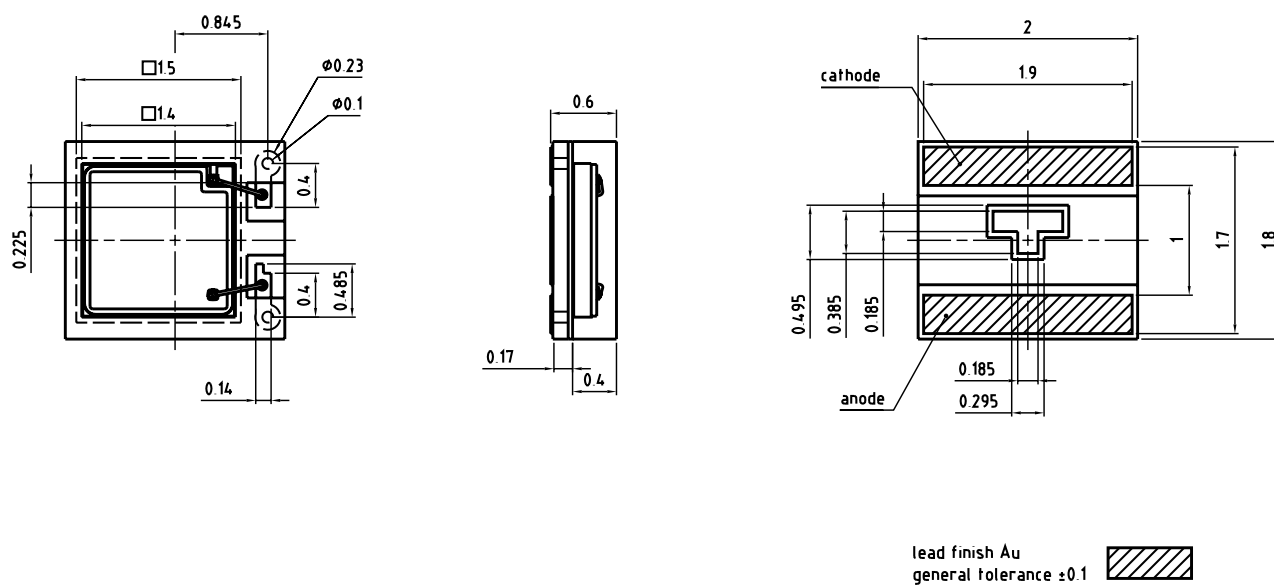


Dark Current ¹⁾

$$I_R = f(T_A); E = 0; V_R = 5 \text{ V}$$



Dimensional Drawing ³⁾

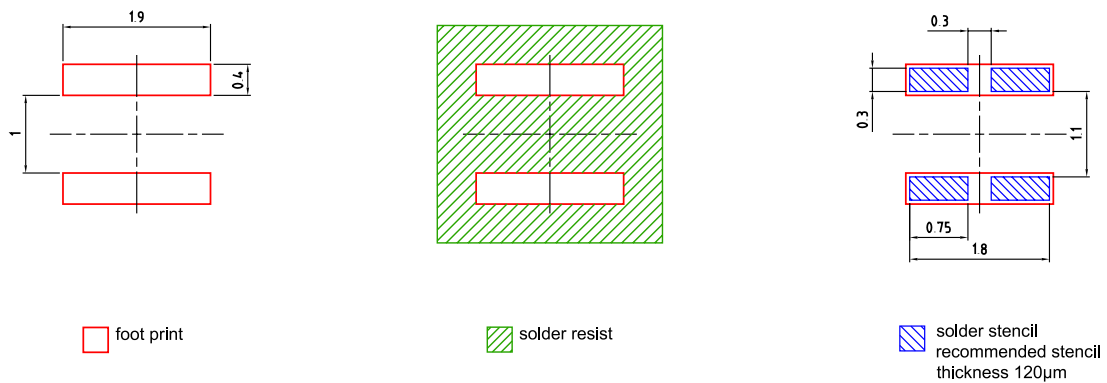


C63062-A4367-A1-04

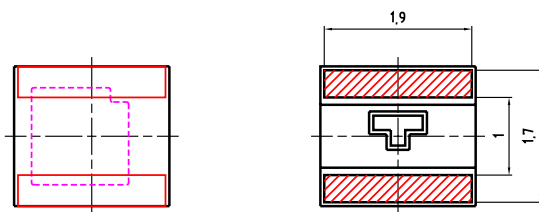
Approximate Weight: 4.4 mg

Package marking: Cathode

Recommended Solder Pad ³⁾



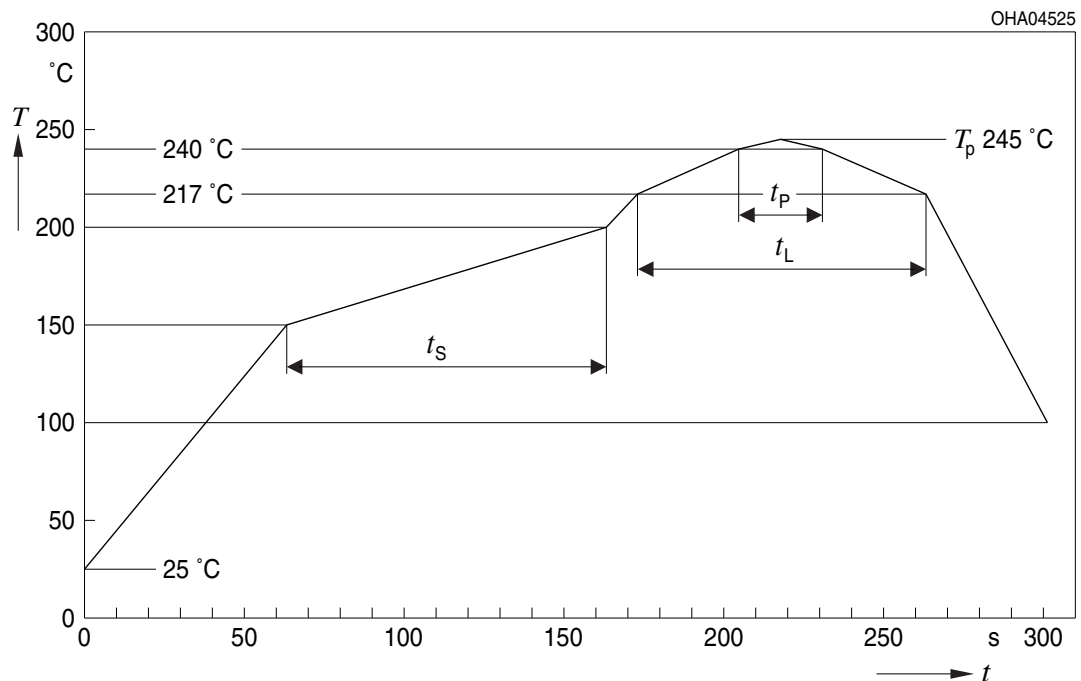
Component Location on Pad



E062.3010.241 -02

Reflow Soldering Profile

Product complies to MSL Level 3 acc. to JEDEC J-STD-020E



* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Technical drawing of a cathode assembly, showing a top view and a side view.

Top View Dimensions:

- Overall width: 8
- Distance from left edge to first hole center: 2
- Distance between hole centers: 4
- Hole diameter: $\phi 1.5$
- Distance from right edge to last hole center: 4
- Distance from hole center to cathode side: 1.75
- Distance from hole center to bottom edge: 3.5
- Distance from left edge to first square feature center: 2.12
- Distance between square feature centers: 4
- Distance from square feature center to bottom edge: 2.12

Side View Dimensions:

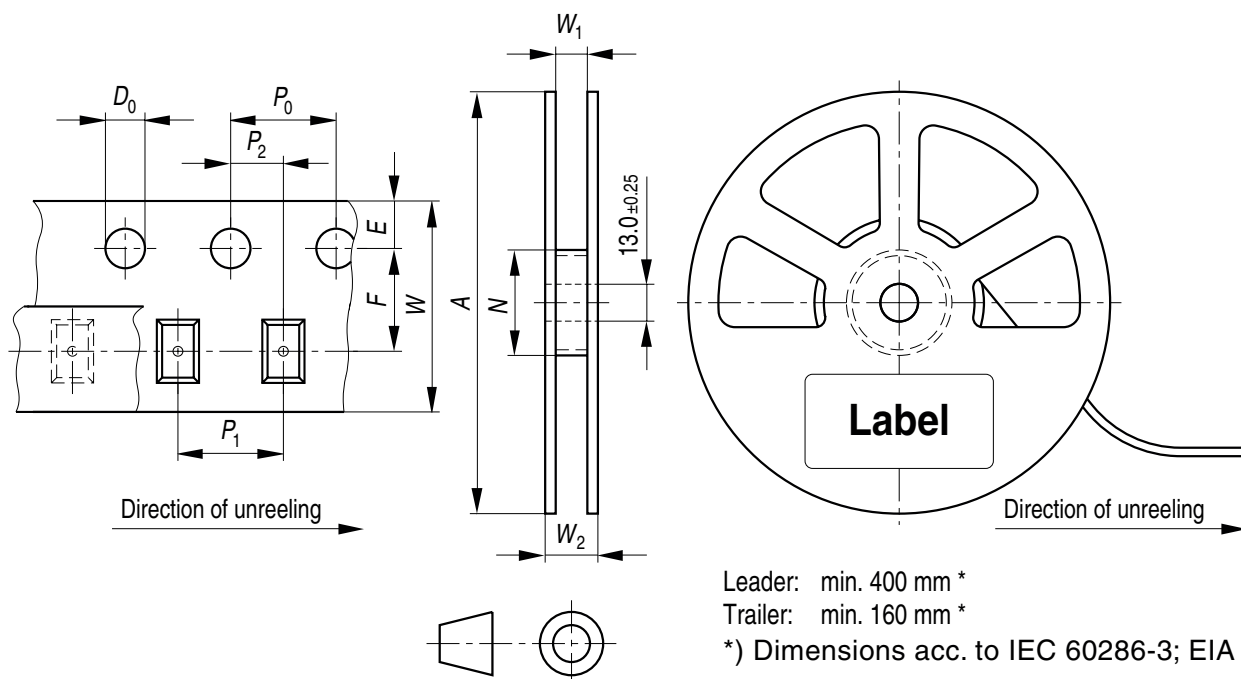
- Overall height: 0.77
- Distance from top edge to cathode side: 0.2
- Distance from cathode side to bottom edge: 2.12

Labels:

- cathode side



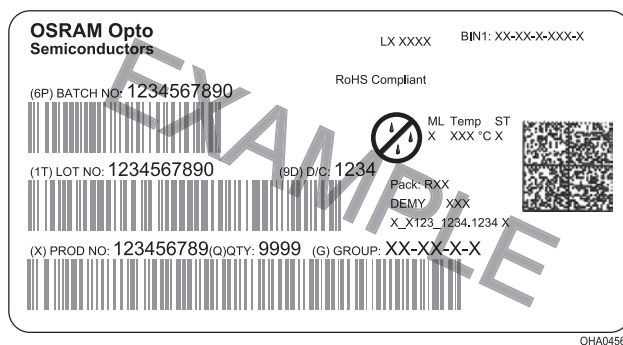
Tape and Reel ⁴⁾



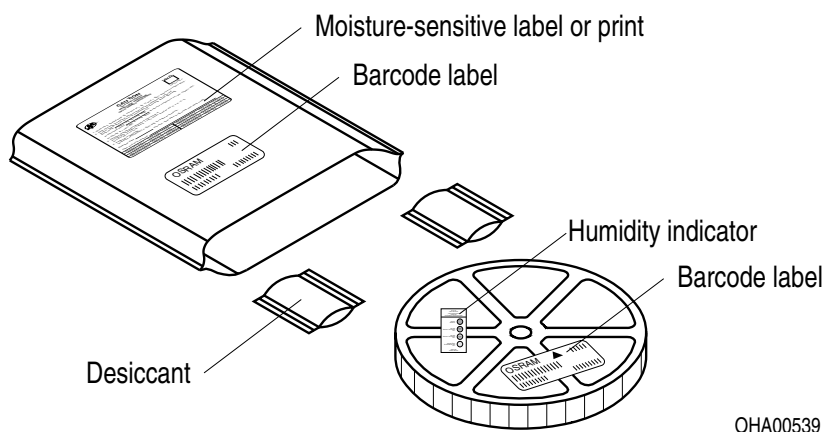
Reel dimensions [mm]

A	W	N _{min}	W ₁	W _{2 max}	Pieces per PU
180 mm	8 + 0.3 / - 0.1	60	8.4 + 2	14.4	3000

Barcode-Product-Label (BPL)

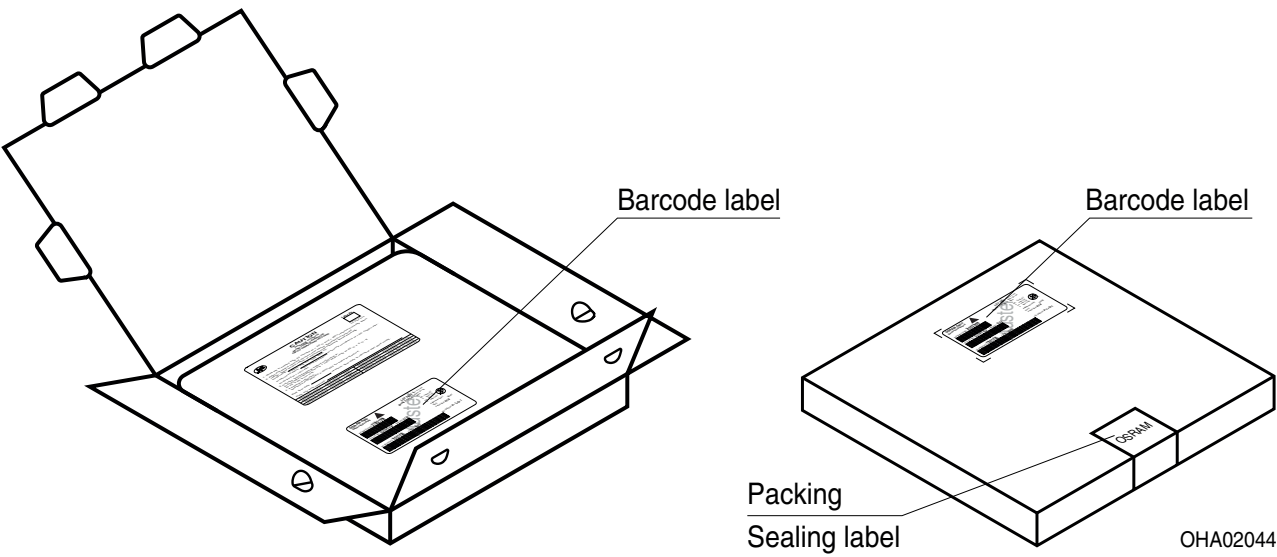


Dry Packing Process and Materials ³⁾



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Transportation Packing and Materials ³⁾



Dimensions of transportation box in mm

Width	Length	Height
200 ± 5 mm	195 ± 5 mm	30 ± 5 mm

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related informations please visit www.osram-os.com/appnotes

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Glossary

- 1) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 2) **Testing temperature:** $T_A = 25^\circ\text{C}$
- 3) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 4) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

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